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SPECIFICATION (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL10A226KQ8NRNE
- Description : CAP, 22^µF, 6.3V, ±10%, X5R, 0603

A. Samsung Part Number

		<u>CL</u> ①	_	<u>A</u> <u>226</u> 3 ④	<u>K</u> 5	<mark>Q</mark> 6	<mark>8</mark> 7	<u>N</u> ®	<u>R</u> 9	<u>N</u> 10	<u>Е</u> 11	
1	Series	Samsung Multi-layer Ceramic Capacitor										
2	Size	0603 (inch c	ode)	L	: 1.6	5 ± 0.2	2	mm		W:	0.8 ± 0.2	mm
3 4	Dielectric Capacitance	X5R 22 μF			8		r ele ninat	ctrode			Ni Cu	
_	Capacitance	±10 %				Plati					Sn 100%	(Pb Free)
	tolerance				9	Proc	luct				Size Control	Code
6	Rated Voltage	6.3 V			10	Spee	cial				Reserved fo	r future use
\bigcirc	Thickness	0.8 ± 0.2	mm		1	Pack	kagin	g			Embossed T	ype, 7"reel

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition					
Capacitance	Within specified tolerance	120Hz ±20% 0.5±0.1Vrms *A capacitor prior to measuring the capacitance is heat treated at 150℃+0/-10℃, and maintained in ambient air for 24±2 hours.					
Tan δ (DF)	0.1 max.						
Insulation Resistance	10,000Mohm or 50Mohm⋅ <i>μ</i> F Whichever is Smaller	Rated Voltage 60~120 sec.					
Appearance	No abnormal exterior appearance	Visual inspection					
Withstanding	No dielectric breakdown or	250% of the rated voltage					
Voltage	mechanical breakdown						
Temperature	X5R						
Characteristics	(From -55 $^{\circ}$ C to 85 $^{\circ}$ C, Capacitance change should be within ±15%)						
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.					
of Termination	terminal electrode						
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) with 1.0mm/sec.					
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder					
	is to be soldered newly	245±5℃, 3±0.3sec.					
		(preheating : 80~120 $^{\circ}$ for 10~30sec.)					
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5 ℃, 10±1sec.					
Soldering heat	Tan δ, IR : initial spec.						

	Performance	Test condition					
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm					
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)					
		2hours \times 3 direction (x, y, z)					
Moisture	Capacitance change : within ±12.5%	With rated voltage					
Resistance	Tan δ : 0.25 max	40±2℃, 90~95%RH, 500+12/-0hrs					
	IR : 500Mohm or 8.8 Mohm $\cdot \mu F$						
	Whichever is Smaller						
High Temperature	Capacitance change : within ±12.5%	With 100% of the rated voltage					
Resistance	Tan δ : 0.25 max	Max. operating temperature					
	IR : 1,000Mohm or 17.7Mohm · <i>μ</i> F						
	Whichever is Smaller	1000+48/-0hrs					
Temperature	Capacitance change : within ±10%	1 cycle condition					
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25 °C					
		$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^\circ\!\!\!\mathrm{C}$					
		5 cycle test					

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 °C, 10sec. Max)

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